3.3V LVCMOS Surface Mount **Crystal Clock Oscillator CWX823**

In Stock at Digi-Key



XO

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The Connor-Winfield CWX823 is a RoHS compliant 3.3V, LVCMOS, 7.0x5.0mm, surface mount, oscillator (XO). This fixed frequency crystal oscillator is designed for use in applications requiring high stability and low jitter. The surface mount package is designed for highdensity mounting and is optimum for mass production.

Features:

1 MHz to 156.25 MHz 3.3V Operation RoHS Compliant / Lead Free Frequency Tolerance: ±50ppm Temperature Range: -20 to 70°C

Low Jitter: <1 pS RMS Tri-State Enable / Disable Ceramic Surface Mount Package Tape and Reel Packaging

Absolute Maximum Ratings

Parameter	Minimum	Nominal	Maximum	Units	Notes
Storage Temperature	-55	-	125	°C	
Supply Voltage (Vcc)	-0.5	-	7.0	Vdc	

Operating Specifications

Parameter	Minimum	Nominal	Maximum	Units	Notes
Frequency Range (Fo)	1.00	-	156.25	MHz	
Frequency Tolerance	-50	-	50	ppm	1
Operating Temperature Range	-20	-	70	°C	
Supply Voltage (Vcc)	3.63	3.30	2.97	Vdc	
Supply Current (Icc)	-	-	30	mA	

Input Characteristics

Parameter	Minimum	Nominal	Maximum	Units	Notes
Enable Voltage - (Vih)	≥ 2.2	-	-	Vdc	2
Disable Voltage - (Vil)	-	-	≤ 0.8	Vdc	

LVCMOS Output Characteristics

Parameter	Minimum	Nominal	Maximum	Units	Notes
Load	-	-	15	рF	
Voltage High (Voh) Low (Vol)	2.97 -		0.33	Vdc	
Current High (loh) Low (lol)	-8 -		- 8	mA	
Duty Cycle at 50% of Vcc	40	50	60	%	
Rise / Fall Time 10% to 80%	-	2	6	ns	
Start-Up Time	-	-	10	ms	
Period Jitter Integrated Phase Jitter (BW=12KHz to 20MHz)	-	3 0.3	5 1.0	ps RMS	

Package Characteristics

Package	Hermetically sealed ceramic package		
Soldering Process RoHS compliant, lead free. See solder profile on page 2.			

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Bulletin

Notes:

1. Inclusive of calibration @ 25°C, frequency vs temperature stability, supply voltage change, load change, shock and vibration, 10 years aging.
2. Oscillator output is enabled with no connection on pad 1

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Environmental Characteristics

The specimen shall meet electrical characteristics after tested 5 cycles of -55°C / 30 minutes and +125°C / 30 minutes Temperature Cycle No bubbles appear in Flourinert (FC-43) at 125°C ±5°C for 5 minutes Hermetical Marking will withstand immersion in Isopropyl Alcohol or Trichloroethylene Solvent Resistance

Soldering

260°C max x 10 sec max x 2 times max or 230°C max x 180 sec max x 1 time General Conditions 20 to 100 sec up to 215°C, 50 sec at 215°C, then down to room temperature per 1 to 5°C / sec Typical Operation Data (Vapor phase reflow)

Mechanical Characteristics

Free Drop The specimen shall meet electrical characteristics after tested 3 times, Free Drop testing on the hard wooden board from a height of 75 cm.

The specimen shall meet electrical characteristics after tested by the following conditions: 10-55Hz 1.5mm Amplitude, 55-2000 Hz 20 G's, 2 hours for each plane Vibration

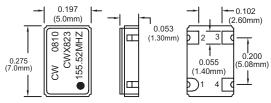
After applied Thermal Shock of 260°C max x 10 sec max x 2 times, or 230°C max x 180 sec max, the specimen shall meet electrical characteristics Thermal Shock

Solderability

(EIAJ-RCX-0102.101 Condition 1a)
Flux: MIL-F-14256 (WW Rosin=25%, Isopropyl Alcohol = 75%)
Solder: QQ-S-571 (Sn = 63%, Pb = 37%)
Solder bath temperature: 235°C ±5°C

Depth of immersion: Up to electrical terminal Immersing time: Within 2 sec ±0.5 sec into solder bath

After performing the above procedures, a newly soldered coverage shall be greater than 90%



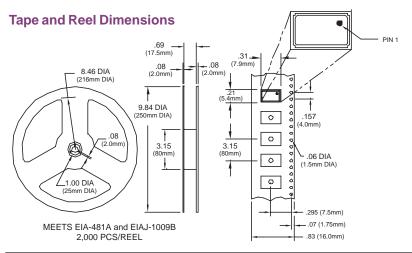
Dimensional Tolerance: ± .008" (±0.2mm)

Pad Connection

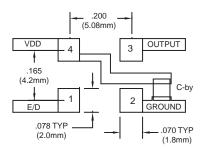
- Enable / Disable
- 2: Ground
- 3: Output
- Vcc

Enable/Disable Function Outnut

Pin 1 Open	Pin 3 Active
Pin 1 ≥ 2.2V	Pin 3 Active
Pin 1 ≤0.8V	Pin 3 High Impedence



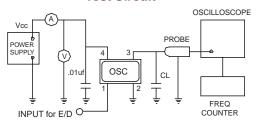
Suggested Pad Layout



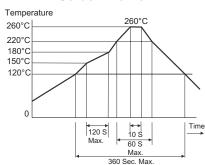
Bypass capacitor. C-by, should be

Dimensional Tolerance: ±.02" (.508mm) ±.008"(0.2mm)

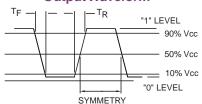
Test Circuit



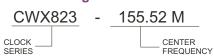
Solder Profile



Output Waveform



Ordering Information



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